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Docket No. XA-10608

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.		
1. Name of conveying party(ies)/Execution Date(s): YOSHIZUMI, Keiichi HIGUCHI, Kazuhisa NAKAJI, Takayuki KOKETSU, Masami YASUOKA, Hideki	2. Name and address of receiving party(ies) Name: Renesas Technology Corp. Address: 4-1, Marunouchi 2-chome	
Execution Date(s): 06/22/2006, 06/26,2006, 06/23/2006, 06/23/2006, and 06/22/2006 Additional name(s) of conveying party(ies) attached? Yes No 3. Nature of conveyance: Security Agreement Change of Name Government Interest Assignment Executive Order 9424, Confirmatory License Other	City: Chiyoda-ku State: Tokyo Country: Japan Zip: Additional name(s) & address(es) attached? Yes No	
4. Application or patent number(s): A. Patent Application No.(s) Additional numbers attached? Yes No		
5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1	
Name: Mitchell W. Shapiro Registration No.: 31,568 Address: Miles & Stockbridge P.C.	7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00 Authorized to be charged to deposit account	
Suite 500 City: McLean	Enclosed – Any excess or insufficiency should be credited or debited to deposit account	
State: Virginia Zip: 22102 Phone Number: 703-610-8652 Fax Number: 703/610-8686 Email Address: mwshapiro@milesstockbridge.com	8. Payment Information a. Credit Card Last 4 Numbers Expiration Date b. Deposit Account Number 50-1165 Authorized User NameMitchell W. Shapiro	
9. Signature: Mitchell W. Shapiro Name of Person Signing	Date August 8, 2006 Total Number of pages including cover sheet, attachments, and documents: 2 eet) should be faxed to (703) 306-5995, or mailed to:	

Documents to be recorded (including cover sheet) should be faxed to (703) 306-5995, or mailed to: Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, VA 22313-1450

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PATENT REEL: 018173 FRAME: 0105

ASSIGNMENT (譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Technology Corp., a corporation organized under the laws of Japan,

located at 4-1, Marunouchi 2-chome, Chiyoda-ku, Tokyo, Japan,

receipt of which is hereby acknowledged I do hereby sell and assign to said Renesas Technology Corp., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

A SEMICONDUTOR DEVICE AND A METHOD OF MANUFACTURING THE SAME

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Renesas Technology Corp.,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made:

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Technology Corp.,

Signed on the date(s) indicated aside our signatures:

RECORDED: 08/08/2006

INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1) Keitchi Yoshiaumi Kelichi Yoshizumi	22/ June / 2006
2) Kazuhisa Higuchi Kazuhisa HIGUCHI	26/June /2006
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6)	
7)	
8)	
9)	·
10)	

PATENT REEL: 018173 FRAME: 0106